

L Number	Hits	Search Text	DB	Time stamp
1	2902	thickness near5 wafer near5 (measur\$4 or determin\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 10:09
2	6158	endpoint near5 (detect\$4 or measur\$4 or determin\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 10:10
3	246	(thickness near5 wafer near5 (measur\$4 or determin\$4)) and (endpoint near5 (detect\$4 or measur\$4 or determin\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 10:10
4	79259	356/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 10:11
5	45	((thickness near5 wafer near5 (measur\$4 or determin\$4)) and (endpoint near5 (detect\$4 or measur\$4 or determin\$4))) and 356/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 10:13
6	201	((thickness near5 wafer near5 (measur\$4 or determin\$4)) and (endpoint near5 (detect\$4 or measur\$4 or determin\$4))) not ((thickness near5 wafer near5 (measur\$4 or determin\$4)) and (endpoint near5 (detect\$4 or measur\$4 or determin\$4))) and 356/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 10:14
-	23025	endpoint	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 08:47
-	2	111 and endpoint	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 08:48
-	2	"20020030826"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 08:48
-	0	"20020030826" and endpoint	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/17 10:08